## Bill of Materials

**TI DESIGNS**
**TIPD140: Op Amp Slew Rate Limiter**

<table>
<thead>
<tr>
<th>Quantity</th>
<th>Designator</th>
<th>Value</th>
<th>Description</th>
<th>Manufacturer</th>
<th>Manufacturer PN</th>
<th>DigiKeyPartNumber</th>
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<tr>
<td>1</td>
<td>U1, U2</td>
<td>OPA192</td>
<td>HV, RRIO, Precision Op Amp</td>
<td>Texas Instruments</td>
<td>OPA192IDR</td>
<td>OPA192IDR-ND</td>
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